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April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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DATA SHEET



MOS FIELD EFFECT TRANSISTOR 2SJ673

SWITCHING P-CHANNEL POWER MOS FET

DESCRIPTION

The 2SJ673 is P-channel MOS Field Effect Transistor designed for high current switching applications.

FEATURES

- Super low on-state resistance
 $R_{DS(on)1} = 20 \text{ m}\Omega \text{ MAX. (} V_{GS} = -10 \text{ V, } I_D = -18 \text{ A)}$
 $R_{DS(on)2} = 31 \text{ m}\Omega \text{ MAX. (} V_{GS} = -4.0 \text{ V, } I_D = -18 \text{ A)}$
- Low C_{iss} : $C_{iss} = 4600 \text{ pF TYP.}$
- Built-in gate protection diode

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$)

Drain to Source Voltage ($V_{GS} = 0 \text{ V}$)	V_{DSS}	-60	V
Gate to Source Voltage ($V_{DS} = 0 \text{ V}$)	V_{GSS}	± 20	V
Drain Current (DC) ($T_C = 25^\circ\text{C}$)	$I_{D(DC)}$	± 36	A
Drain Current (pulse) ^{Note1}	$I_{D(pulse)}$	± 144	A
Total Power Dissipation ($T_C = 25^\circ\text{C}$)	P_{T1}	32	W
Total Power Dissipation ($T_A = 25^\circ\text{C}$)	P_{T2}	2.0	W
Channel Temperature	T_{ch}	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55 to +150	$^\circ\text{C}$
Single Avalanche Current ^{Note2}	I_{AS}	-36	A
Single Avalanche Energy ^{Note2}	E_{AS}	130	mJ

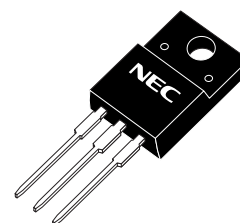
Notes 1. $PW \leq 10 \mu\text{s}$, Duty Cycle $\leq 1\%$

2. Starting $T_{ch} = 25^\circ\text{C}$, $V_{DD} = -30 \text{ V}$, $R_G = 25 \Omega$, $V_{GS} = 20 \rightarrow 0 \text{ V}$

ORDERING INFORMATION

PART NUMBER	PACKAGE
2SJ673	Isolated TO-220 (MP-45F)

(Isolated TO-220)



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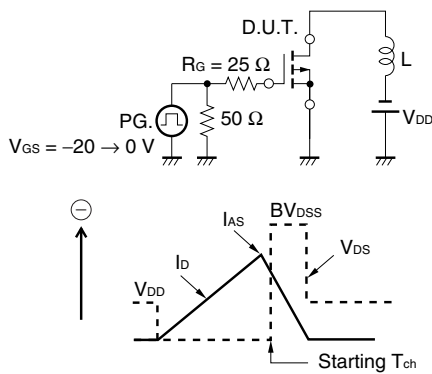
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ELECTRICAL CHARACTERISTICS (T_A = 25°C)

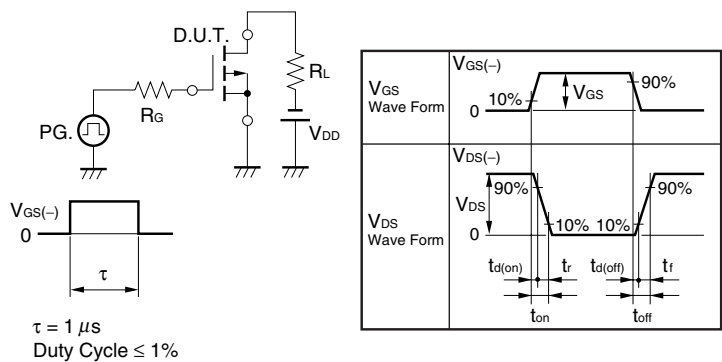
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -60 V, V _{GS} = 0 V			-10	μA
Gate Leakage Current	I _{GSS}	V _{GS} = ±20 V, V _{DS} = 0 V			±10	μA
Gate Cut-off Voltage	V _{GS(off)}	V _{DS} = -10 V, I _D = -1 mA	-1.5	-2.0	-2.5	V
Forward Transfer Admittance ^{Note}	y _{fs}	V _{DS} = -10 V, I _D = -18 A	22			S
Drain to Source On-state Resistance ^{Note}	R _{DS(on)1}	V _{GS} = -10 V, I _D = -18 A		17	20	mΩ
	R _{DS(on)2}	V _{GS} = -4.0 V, I _D = -18 A		22	31	mΩ
Input Capacitance	C _{iss}	V _{DS} = -10 V		4600		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V		820		pF
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		330		pF
Turn-on Delay Time	t _{d(on)}	V _{DD} = -30 V, I _D = -18 A		14		ns
Rise Time	t _r	V _{GS} = -10 V		14		ns
Turn-off Delay Time	t _{d(off)}	R _G = 0 Ω		130		ns
Fall Time	t _f			50		ns
Total Gate Charge	Q _G	V _{DD} = -48 V		87		nC
Gate to Source Charge	Q _{GS}	V _{GS} = -10 V		15		nC
Gate to Drain Charge	Q _{GD}	I _D = -36 A		22		nC
Body Diode Forward Voltage ^{Note}	V _{F(S-D)}	I _F = -36 A, V _{GS} = 0 V		1.0		V
Reverse Recovery Time	t _{rr}	I _F = -36 A, V _{GS} = 0 V		52		ns
Reverse Recovery Charge	Q _{rr}	di/dt = 100 A/μs		84		nC

Note Pulsed

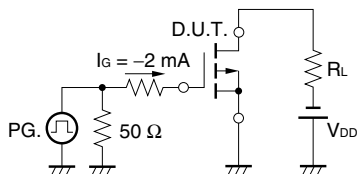
TEST CIRCUIT 1 AVALANCHE CAPABILITY



TEST CIRCUIT 2 SWITCHING TIME

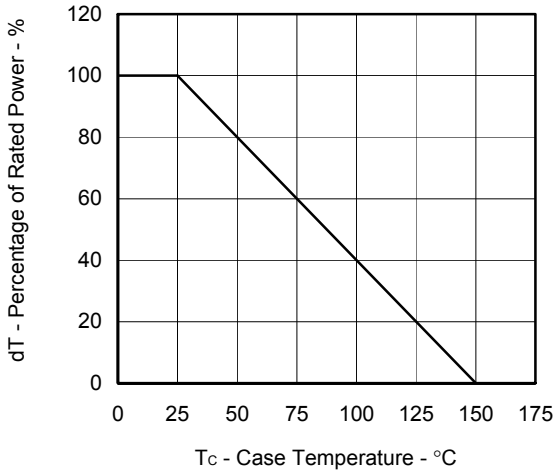


TEST CIRCUIT 3 GATE CHARGE

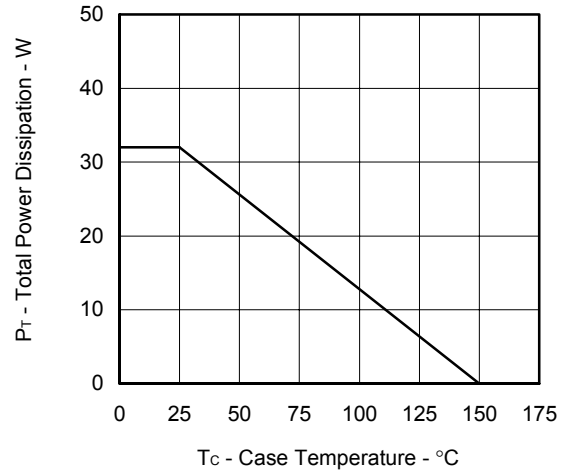


TYPICAL CHARACTERISTICS (T_A = 25°C)

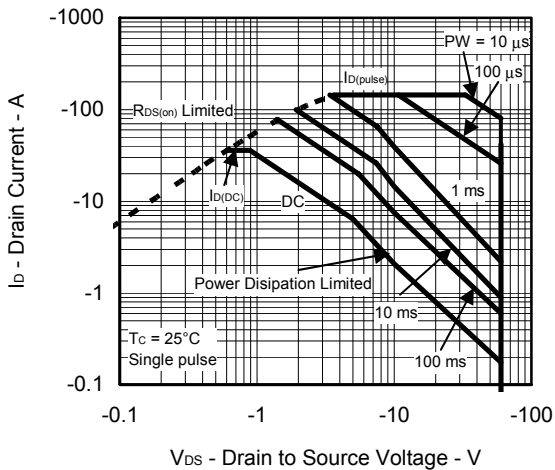
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



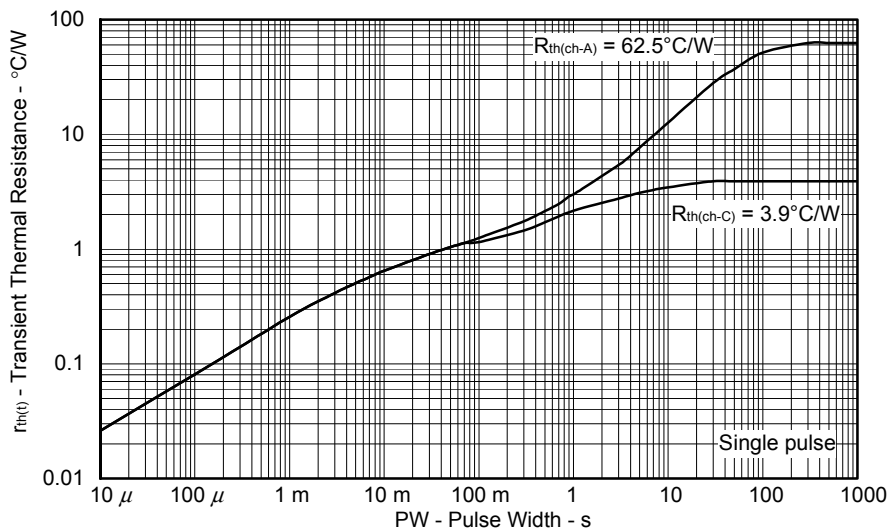
TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



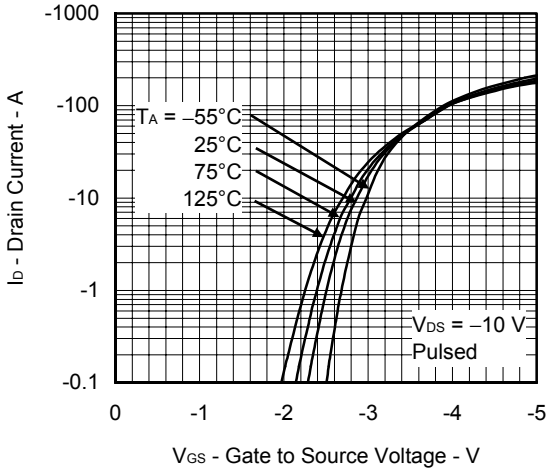
FORWARD BIAS SAFE OPERATING AREA



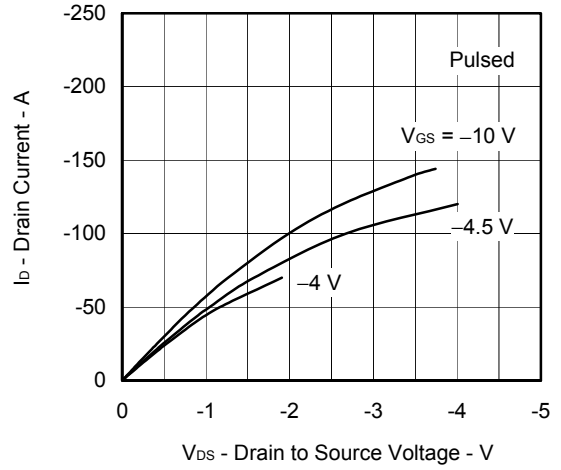
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



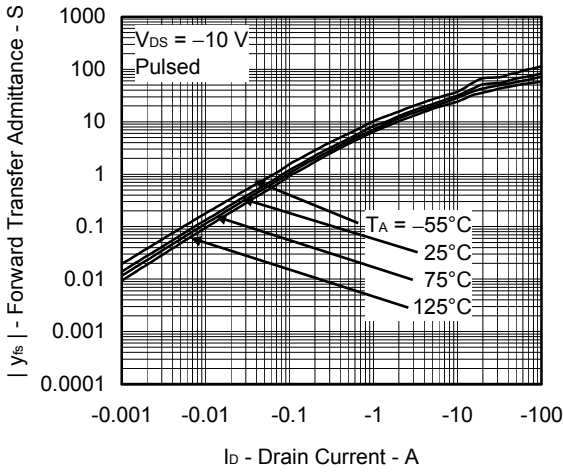
FORWARD TRANSFER CHARACTERISTICS



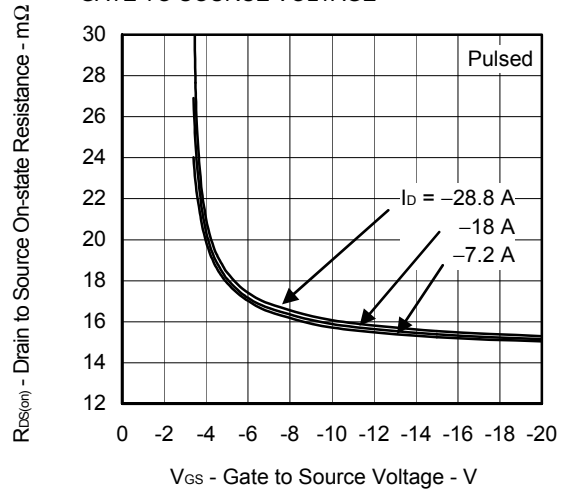
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



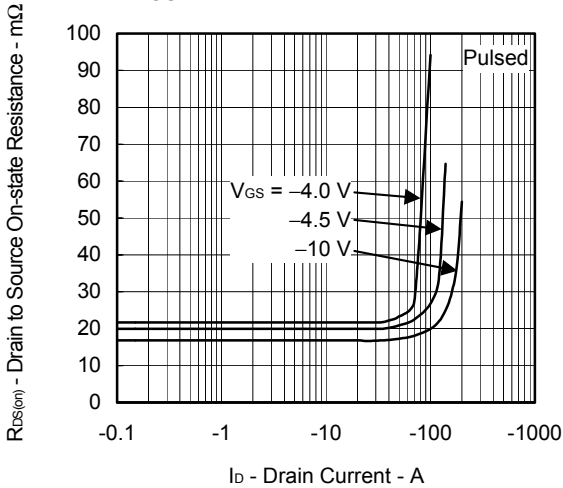
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



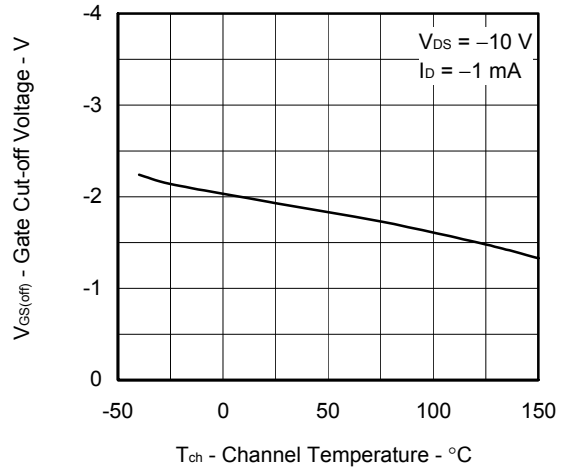
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

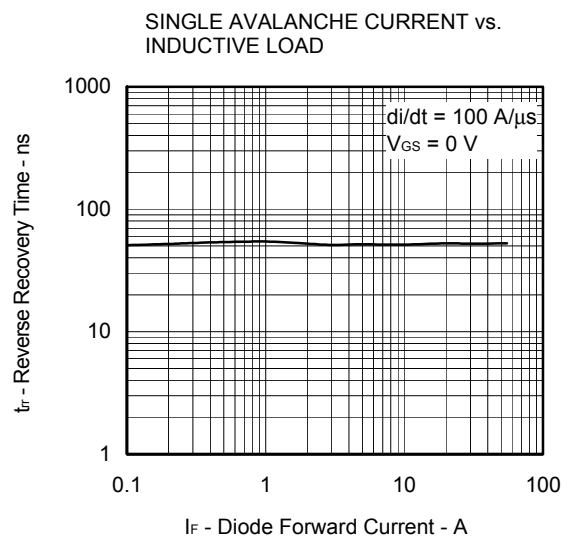
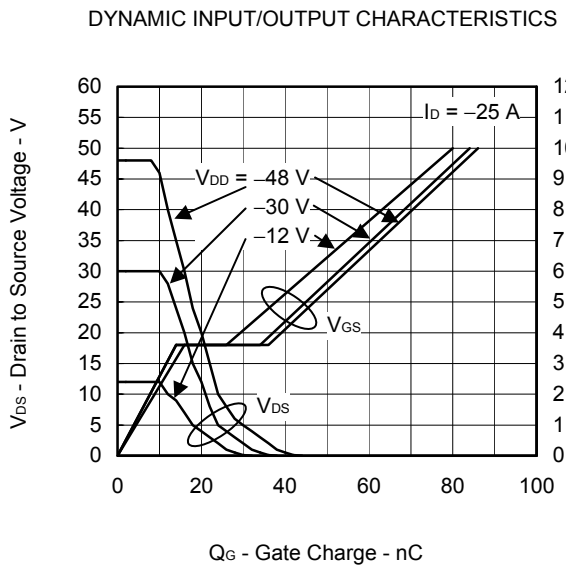
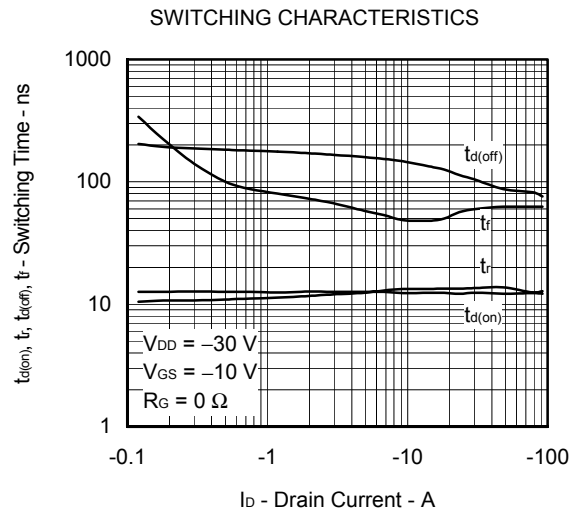
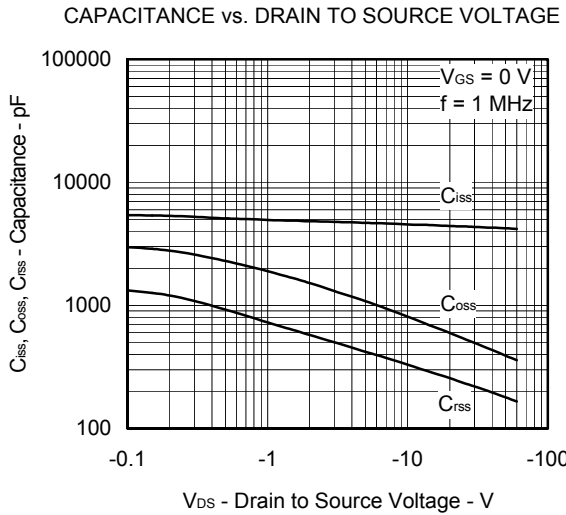
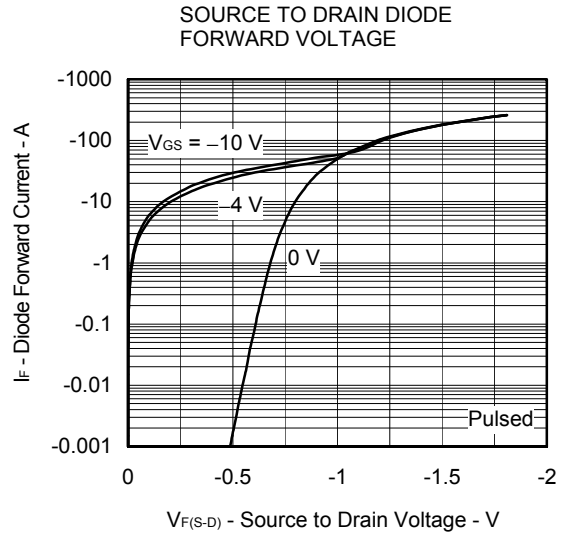
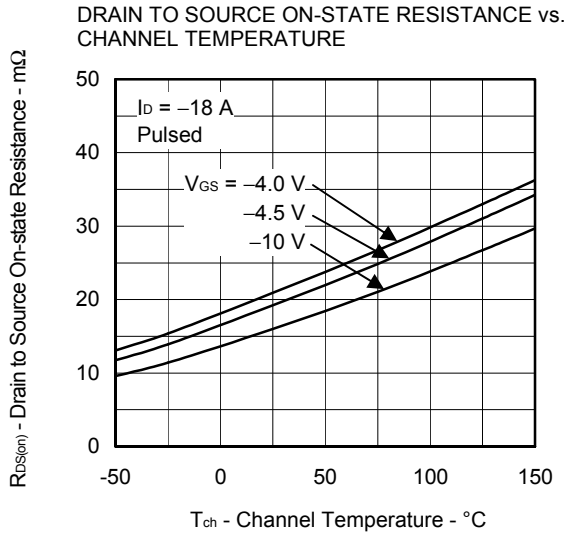


DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

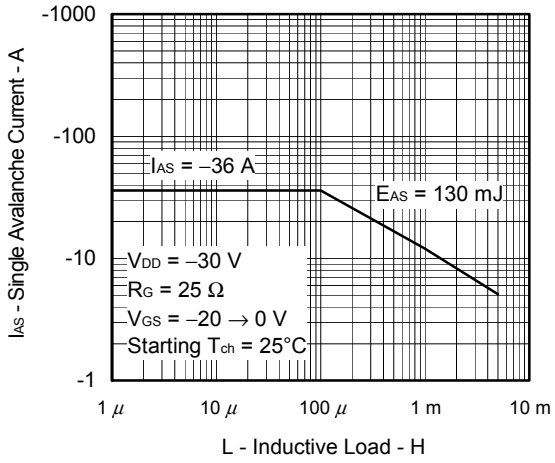


GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE

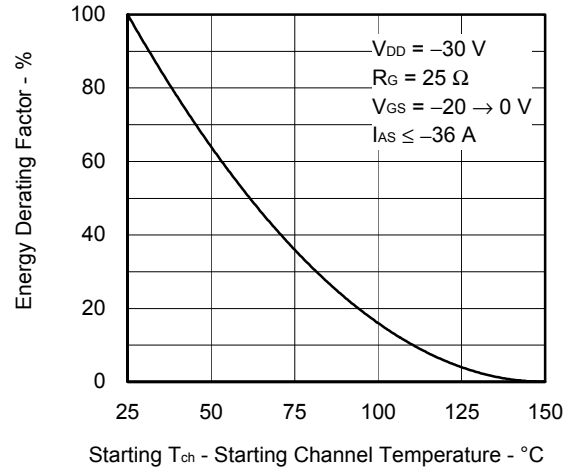




SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD

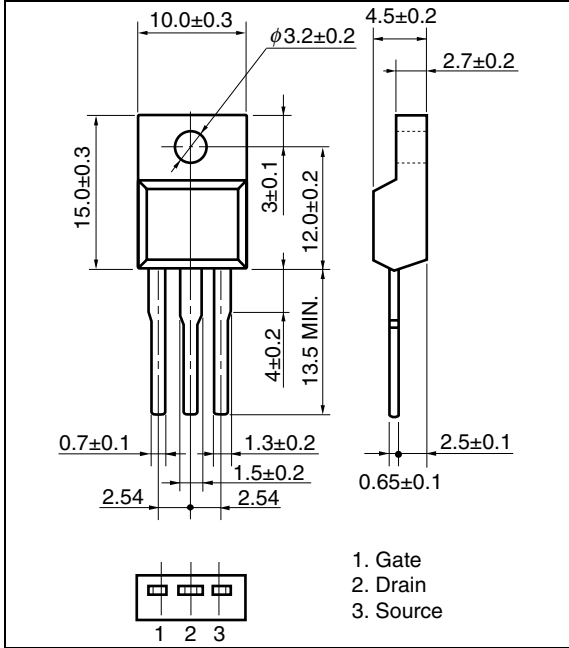


SINGLE AVALANCHE ENERGY DERATING FACTOR

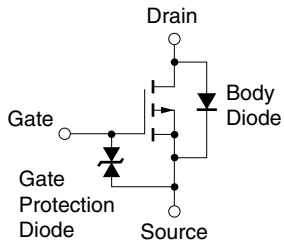


PACKAGE DRAWING (Unit: mm)

Isolated TO-220 (MP-45F)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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